

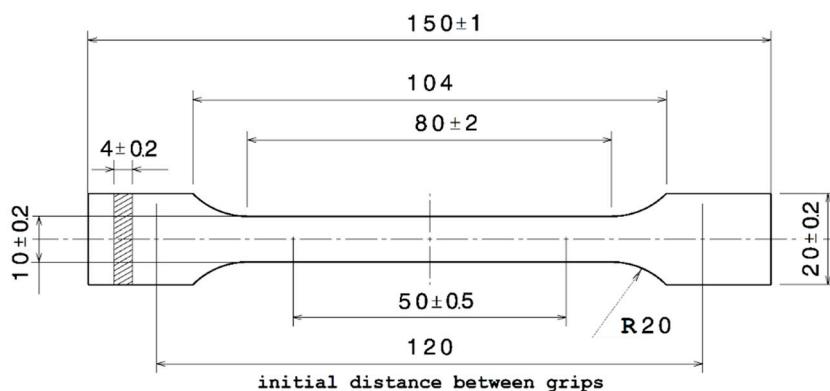
## Supplementary Materials

# On the Thermomechanical Behavior of 3D-Printed Specimens of Shape Memory R-PETG

Ştefan-Dumitru Sava, Nicoleta-Monica Lohan, Bogdan Pricop, Mihai Popa, Nicanor Cimpoeşu,  
Radu-Ioachim Comănci and Leandru-Gheorghe Bujoreanu \*

Faculty of Materials Science, "Gheorghe Asachi" Technical University of Iaşi, Blvd. Dimitrie Mangeron 71A, 700050 Iasi, Romania; stefan-dumitru.sava@student.tuiasi.ro (Ş.-D.S.); nicoleta-monica.lohan@academic.tuiasi.ro (N.-M.L.); bogdan.pricop@academic.tuiasi.ro (B.P.); mihai.popa@academic.tuiasi.ro (M.P.); nicanor.cimpoeşu@academic.tuiasi.ro (N.C.); radu-ioachim.comanici@academic.tuiasi.ro (R.-I.C.)

\* Correspondence: leandru-gheorghe.bujoreanu@academic.tuiasi.ro; Tel.: +40-727-486-406



Specimen geometry according to EN ISO 527-2

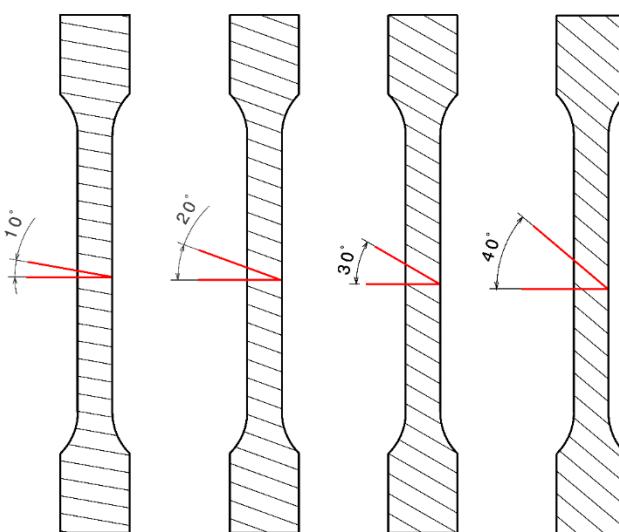


Illustration of the printing angle between transversal direction and filament deposition direction

**Figure S1.** 3D printed specimen geometry and deposition angle.

**Table S1.** Summary of the values of the printing parameters and printer® specifications.

	Build Surface	Extruder temperature	Bed temperature	Nozzle height	Printing speed	Travel speed	Cooling
Printing parameters	PEI (Polyetherimide)	205-220 °C	60-70 °C	0.1-0.2mm	20-80mm/s	120mm/s	moderate
	Style	Frame	Build volume, mm	Extruder configuration	Extruder	Accuracy	Speed
Printer® specifications	CoreXY Cartesian	Aluminum extrusions with 3D printed parts	210 x 130 x 140	Direct	Bondtech BMG extruder (3:1 gear ratio)	0.2-0.4mm	20-130mm/s
	Bed leveling	Stepper motors	Voltage	Mainboard	Bed surface	Firmware	Computer
manual leveling	NEMA 17	24 V (with Meanwell PSU)	SKR V1.4 with TMC2209 stepper motor drivers	PEI sheet	Klipper	Raspberry Pi 4 (to work with Klipper firmware)	